

# **Customer Information Notification**

03-Jun-2017 Issue Date: Effective Date: 04-Jun-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

# 2017050241



# **Change Category**

[] Wafer Fab Process [] Assembly[] Product Marking [] Test [] Design **Process** Location

[] Wafer Fab Materials [] Assembly[] Mechanical []Test [X] Errata

Materials Specification **Process** 

[] Wafer Fab Location [] Assembly[] [] Test [X] Electrical Location

Packing/Shipping/Labeling Equipment spec./Test coverage

SAC57D54H Datasheet. Reference Manual **Update And Errata Publish** 

## **Information Notification**

NXP Semiconductors is announcing the update of datasheet, reference manual and errata for SAC57D54H. The datasheet will be updated from revision 6 to revision 7.

The reference manual will be updated from revision 4.2 to revision 6.

The SAC57D54H errata published for mask set 0N87P will be revision, 6 April 2017.

The SAC57D54H errata published for mask set 1N87P will be revision, 3 April 2017.

The updated documentation is attached to this notice or can be found at:

http://www.nxp.com/products/microcontrollers-and-processors/arm-processors/mac57dxxx/ultra-reliablemulti-core-arm-based-mcu-for-clusters-and-display-management:MAC57D5xx?tab=Documentation\_Tab

## Why do we issue this Information Notification?

The datasheet and reference manual for SAC57D54H have been updated to correct errors and provide additional technical clarification on some device features.

The errata was published.

#### **Identification of Affected Products**

Product identification does not change

#### **Impact**

no impact to the product's functionality anticipated.

## **Data Sheet Revision**

A new datasheet will be issued

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Keng How Quek
Position Product Engineer
e-mail address keng.quek@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

## **About NXP Semiconductors**

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

View Notification	Subscription	Support
-------------------	--------------	---------

NXP | Privacy Policy | Terms of Use

**NXP Semiconductors** 

High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.

#### **Affected Part Numbers**

SAC57D54HCVMO SAC57D54HCVLT SAC57D54HCVMO